

# STGD7NB60S

## N-CHANNEL 7A - 600V DPAK Power MESH<sup>™</sup> IGBT

TYPE	V <sub>CES</sub>	V <sub>CE(sat)</sub>	I <sub>C</sub>
STGD7NB60S	600 V	< 1.6 V	7 A
		-	

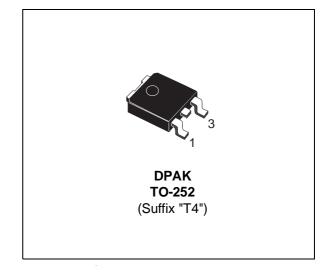
- HIGH INPUT IMPEDANCE (VOLTAGE DRIVEN)
- VERY LOW ON-VOLTAGE DROP (V<sub>cesat</sub>)
- HIGH CURRENT CAPABILITY
- OFF LOSSES INCLUDE TAIL CURRENT
- SURFACE-MOUNTING DPAK (TO-252) POWER PACKAGE IN TAPE & REEL (SUFFIX "T4")

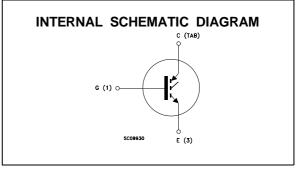
#### DESCRIPTION

Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESH<sup>TM</sup> IGBTs, with outstanding perfomances. The suffix "S" identifies a family optimized to achieve minimum on-voltage drop for low frequency applications (<1kHz).

## APPLICATIONS

- LIGHT DIMMER
- STATIC RELAYS
- MOTOR CONTROL





Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-Emitter Voltage (V <sub>GS</sub> = 0)	600	V
Vecr	Reverse Battery Protection	20	V
$V_{GE}$	Gate-Emitter Voltage	± 20	V
Ι <sub>C</sub>	Collector Current (continuous) at T <sub>c</sub> = 25 °C	15	А
Ι <sub>C</sub>	Collector Current (continuous) at T <sub>c</sub> = 100 °C	7	А
I <sub>СМ</sub> (●)	Collector Current (pulsed)	60	A
P <sub>tot</sub>	Total Dissipation at $T_c = 25$ °C	55	W
	Derating Factor	0.44	W/°C
T <sub>stg</sub>	Storage Temperature	-65 to 150	°C
Тj	Max. Operating Junction Temperature	150	°C

ABSOLUTE MAXIMUM RATINGS

(•) Pulse width limited by safe operating area

## THERMAL DATA

R <sub>thj-case</sub>	Thermal Resistance Junction-case	Max	2.27	°C/W
R <sub>thj-amb</sub>	Thermal Resistance Junction-ambient	Max	100	°C/W
R <sub>thc-sink</sub>	Thermal Resistance Case-sink	Тур	1.5	°C/W

# **ELECTRICAL CHARACTERISTICS** (T<sub>j</sub> = 25 $^{\circ}$ C unless otherwise specified) OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V <sub>BR(CES)</sub>	Collector-Emitter Breakdown Voltage	$I_{C} = 250 \ \mu A$ $V_{GE} = 0$	600			V
V <sub>BR(ECR)</sub>	Emitter-Collector Breakdown Voltage	IC = 1 mA V <sub>GE</sub> = 0	20			V
I <sub>CES</sub>	Collector cut-off $(V_{GE} = 0)$				10 100	μΑ μΑ
I <sub>GES</sub>	Gate-Emitter Leakage Current (V <sub>CE</sub> = 0)	$V_{GE} = \pm 20 \text{ V} \qquad \qquad V_{CE} = 0$			± 100	nA

## ON (\*)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
$V_{\text{GE(th)}}$	Gate Threshold Voltage	$V_{CE} = V_{GE}$ I <sub>C</sub> = 250 µA	2.5		5	V
V <sub>CE(SAT)</sub>	Collector-Emitter Saturation Voltage	$ \begin{array}{ll} V_{GE} = 15 \ V & I_C = 3 \ A \\ V_{GE} = 15 \ V & I_C = 7 \ A \\ V_{GE} = 15 \ V & I_C = 7 \ A & T_j = 125 \ ^{o}C \end{array} $		1 1.2 1.1	1.4 1.6	V V V

## DYNAMIC

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
<b>g</b> fs	Forward Transconductance	V <sub>CE</sub> =25 V I <sub>C</sub> = 7 A		4			S
C <sub>ies</sub> C <sub>oes</sub> C <sub>res</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V <sub>CE</sub> = 25 V f = 1 MHz V <sub>0</sub>	<sub>GE</sub> = 0		610 65 12	780 85 15	pF pF pF
$Q_G$	Gate Charge	$V_{CE} = 400 \text{ V}$ $I_{C} = 7 \text{ A}$ $V_{CE} = 7 \text{ A}$	<sub>GE</sub> = 15 V		33		nC
I <sub>CL</sub>	Latching Current	$V_{clamp} = 480 V$ F T <sub>j</sub> = 150 °C	$R_G=1k\Omega$	15			A

## SWITCHING ON

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub>	Delay Time Rise Time	V <sub>CC</sub> = 480 V V <sub>GE</sub> = 15 V	$I_{C} = 7 A$ $R_{G} = 1 K\Omega$		0.7 0.46		μs μs
(di/dt) <sub>on</sub>	Turn-on Current Slope	V <sub>CC</sub> = 480 V R <sub>G</sub> = 1 KΩ	I <sub>C</sub> = 7 A V <sub>GE</sub> = 15 V		8		A/μs
Eon	Turn-on Switching Losses	T <sub>j</sub> = 125 °C	-		0.4		mJ

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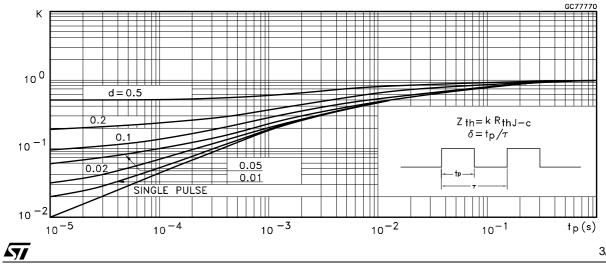
## ELECTRICAL CHARACTERISTICS (continued)

## SWITCHING OFF

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
t <sub>c</sub> t <sub>r</sub> (v <sub>off</sub> ) t <sub>f</sub> E <sub>off</sub> (**)	Cross-Over Time Off Voltage Rise Time Fall Time Turn-off Switching Loss	V <sub>CC</sub> = 480 V R <sub>GE</sub> = 100 Ω	I <sub>C</sub> = 7 A V <sub>GE</sub> = 15 V		2.2 1.2 1.2 3.5		μs μs μs mJ
t <sub>c</sub> t <sub>r</sub> (v <sub>off</sub> ) t <sub>f</sub> E <sub>off</sub> (**)	Cross-Over Time Off Voltage Rise Time Fall Time Turn-off Switching Loss	V <sub>CC</sub> = 480 V R <sub>GE</sub> = 100 Ω T <sub>j</sub> = 125 °C	I <sub>C</sub> = 7 A V <sub>GE</sub> = 15 V		3.8 1.2 1.9 5.3		μs μs μs mJ

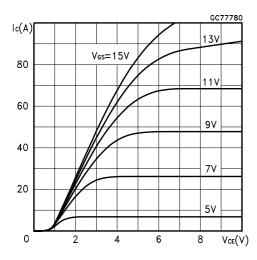
(•) Pulse width limited by safe operating area
(\*) Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %
(\*\*)Losses Include Also The Tail (Jedec Standardization)

#### Thermal Impedance

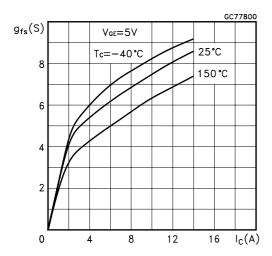


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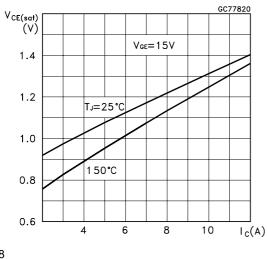
## **Output Characteristics**



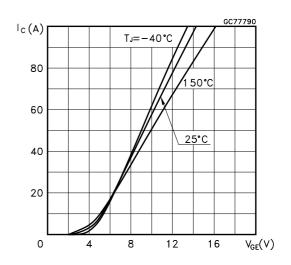
#### Transconductance



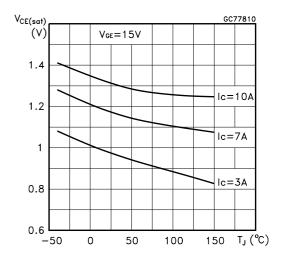
## Collector-Emitter On Voltage vs Collector Current

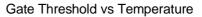


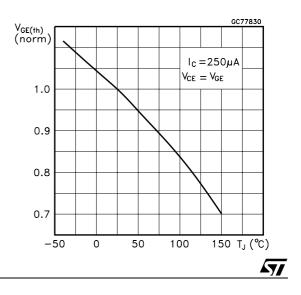
**Transfer Characteristics** 

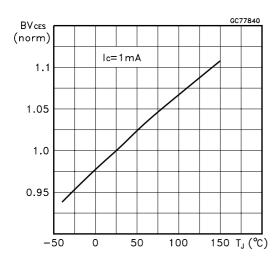


#### Collector-Emitter On Voltage vs Temperature



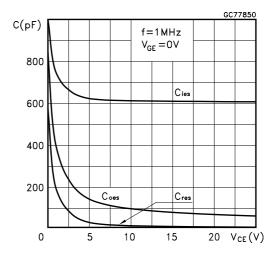




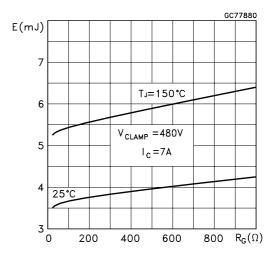


## Normalized Breakdown Voltage vs Temperature

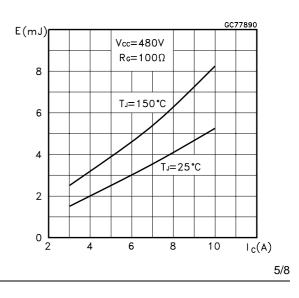
**Capacitance Variations** 



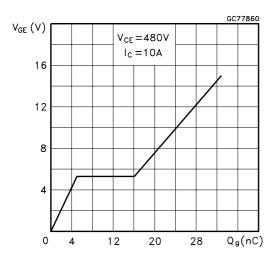
#### Off Losses vs Gate Resistance

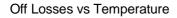


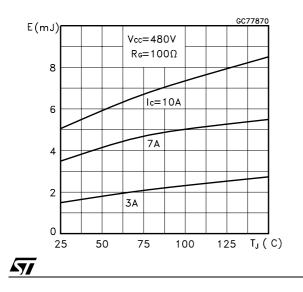




Gate Charge vs Gate-Emitter Voltage







## Switching Off Safe Operatin Area

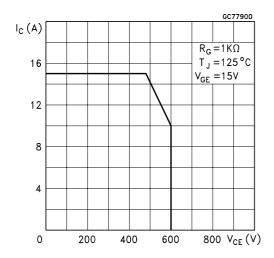
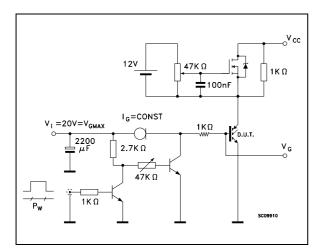
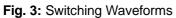


Fig. 1: Gate Charge test Circuit





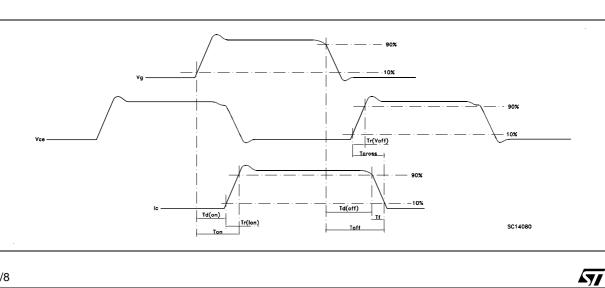
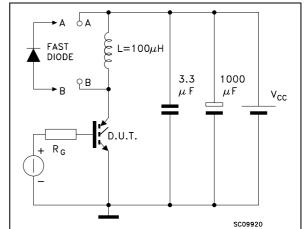
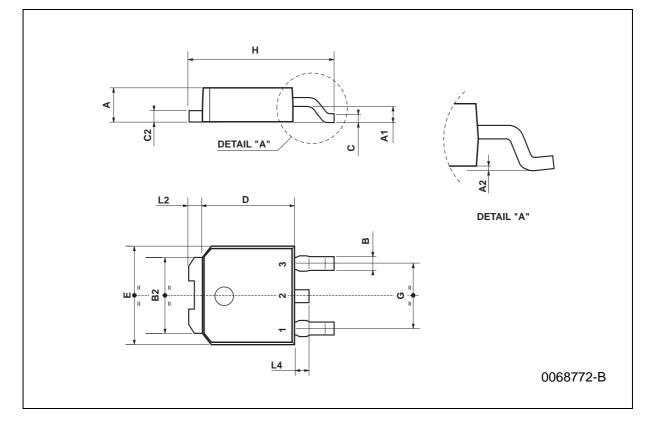


Fig. 2: Test Circuit For Inductive Load Switching



DIM.		mm			inch	
Divi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	2.2		2.4	0.086		0.094
A1	0.9		1.1	0.035		0.043
A2	0.03		0.23	0.001		0.009
В	0.64		0.9	0.025		0.035
B2	5.2		5.4	0.204		0.212
С	0.45		0.6	0.017		0.023
C2	0.48		0.6	0.019		0.023
D	6		6.2	0.236		0.244
Е	6.4		6.6	0.252		0.260
G	4.4		4.6	0.173		0.181
Н	9.35		10.1	0.368		0.397
L2		0.8			0.031	
L4	0.6		1	0.023		0.039





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